

# HMC466LP4 / 466LP4E

v03.1109



MMIC VCO w/ BUFFER AMPLIFIER, 6.1 - 6.72 GHz

### **Typical Applications**

Low noise MMIC VCO w/Buffer Amplifier for:

- VSAT & Microwave Radio
- CATV & Broadcast Relays
- Test Equipment & Industrial Controls
- Military

#### **Features**

Pout: +4.5 dBm

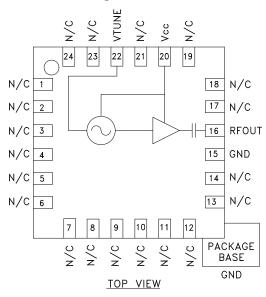
Phase Noise: -101 dBc/Hz @100 KHz

No External Resonator Needed

Single Supply: +3V @ 31 mA

24 Lead 4x4mm QFN Package: 16 mm<sup>2</sup>

#### **Functional Diagram**



#### **General Description**

The HMC466LP4 & HMC466LP4E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs with integrated resonators, negative resistance devices, varactor diodes, and buffer amplifiers. Covering 6.1 to 6.72 GHz, the VCO's phase noise performance is excellent over temperature, shock, vibration and process due to the oscillator's monolithic structure. Power output is 4.5 dBm typical from a single supply of 3V @31mA. The voltage controlled oscillator is packaged in a low cost leadless QFN 4 x 4 mm surface mount package.

# Electrical Specifications, $T_A = +25^{\circ}$ C, Vcc = +3V

Parameter	Min.	Тур.	Max.	Units
Frequency Range	6.1 - 6.72		GHz	
Power Output	1.5	4.5		dBm
SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RF Output		-101		dBc/Hz
Tune Voltage (Vtune)	0		10	V
Supply Current (Icc) (Vcc = +3V)		31		mA
Tune Port Leakage Current			10	μΑ
Output Return Loss		7		dB
Harmonics 2nd 3rd		-13 -24		dBc dBc
Pulling (into a 2.0:1 VSWR)		11		MHz pp
Pushing @ Vtune= +5V		30		MHz/V
Frequency Drift Rate		0.8		MHz/°C

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

# **HMC466\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 02/23/2017

# COMPARABLE PARTS 🖵

View a parametric search of comparable parts.

### **EVALUATION KITS**

· HMC466LP4 Evaluation Board

### **DOCUMENTATION**

#### **Application Notes**

 Determining the FM Bandwidth of a Wideband Varactor Tuned VCO

#### **Data Sheet**

· HMC466 Data Sheet

### REFERENCE MATERIALS $\Box$

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Package/Assembly Qualification Test Report: Plastic Encapsulated QFN (QTR: 05006 REV: 02)
- Semiconductor Qualification Test Report: GaAs HBT-A (QTR: 2013-00228)

# **DESIGN RESOURCES**

- HMC466 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

#### **DISCUSSIONS**

View all HMC466 EngineerZone Discussions.

### SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

# **TECHNICAL SUPPORT**

Submit a technical question or find your regional support number.

#### DOCUMENT FEEDBACK $\Box$

Submit feedback for this data sheet.

This page is dynamically generated by Analog Devices, Inc., and inserted into this data sheet. A dynamic change to the content on this page will not trigger a change to either the revision number or the content of the product data sheet. This dynamic page may be frequently modified.

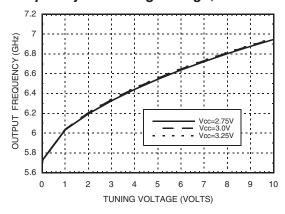


v03.1109

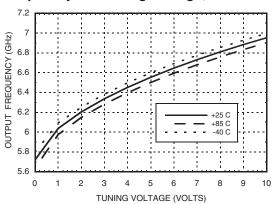


# MMIC VCO w/ BUFFER AMPLIFIER, 6.1 - 6.72 GHz

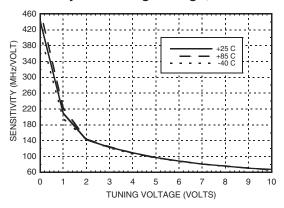
#### Frequency vs. Tuning Voltage, T= 25°C



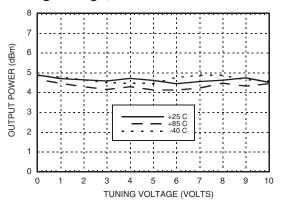
#### Frequency vs. Tuning Voltage, Vcc= +3V



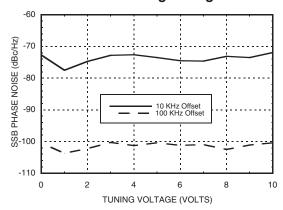
#### Sensitivity vs. Tuning Voltage, Vcc= +3V



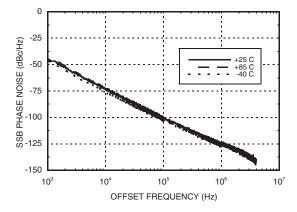
# Output Power vs. Tuning Voltage, Vcc= +3V



#### Phase Noise vs. Tuning Voltage



#### Typical SSB Phase Noise @ Vtune= +5V



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

v03.1109



# MMIC VCO w/ BUFFER AMPLIFIER, 6.1 - 6.72 GHz

#### **Absolute Maximum Ratings**

Vcc	+3.5 Vdc	
Vtune	0 to +11V	
Channel Temperature	135 °C	
Continuous Pdiss (T = 85°C) (derate 6.28 mW/°C above 85°C)	5.65 W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	

### Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
2.75	22
3.0	31
3.25	41

Note: VCO will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS** 

### **Outline Drawing**

# **BOTTOM VIEW PIN 24** -.016 [0.40] REF .012 \[ 0.30 \] .007 \[ 0.18 \] .008 [0.20] MIN PIN 1 HNNN XXXX 13 EXPOSED GROUND PADDLE LOT NUMBER MUST BE CONNECTED TO RF/DC GROUND

# SEATING PLANE .003[0.08]|c C-

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOT FOR SUGGESTED LAND PATTERN.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC466LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H466 XXXX
HMC466LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H466 XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D



v03.1109

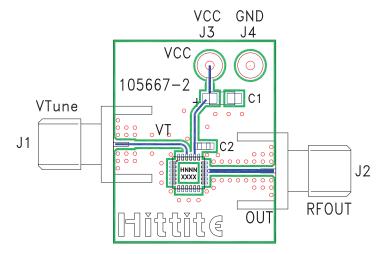


# MMIC VCO w/ BUFFER AMPLIFIER, 6.1 - 6.72 GHz

#### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1- 14, 17 - 19, 21, 23, 24	N/C	No Connection	
15	GND	This pin must be connected to RF & DC ground. Package bottom has an exposed metal paddle that must be RF & DC grounded.	GND =
16	RFOUT	RF output (AC coupled)	—   —○ RFOUT
20	Vcc	Supply Voltage Vcc= 3V	Vcc O26pF
22	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	VTUNE 0 1500 5.2pF

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 105706 [1]

Item	Description
J1 - J2	PCB Mount SMA RF Connector
J3 - J4	DC Pin
C1	4.7 μF Tantalum Capacitor
C2	10,000 pF Capacitor, 0603 Pkg.
U1	HMC466LP4 / HMC466LP4E VCO
PCB [2]	105667 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.